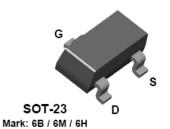
February 2009

2N5484/5485/5486 MMBF5484/5485/5486





NOTE: Source & Drain are interchangeable

N-Channel RF Amplifier

This device is designed primarily for electronic switching applications such as low On Resistance analog switching. Sourced from Process 50.

Absolute Maximum Ratings*

TA = 25°C unless otherwise noted

Symbol	Parameter	Value	Units	
V_{DG}	Drain-Gate Voltage	25	V	
V _{GS}	Gate-Source Voltage	- 25	V	
I _{GF}	Forward Gate Current	10	mA	
T _J ,T _{stg}	Operating and Storage Junction Temperature Range	-55 to +150	°C	

^{*}These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

NOTES

1) These ratings are based on a maximum junction temperature of 150 degrees C.

Thermal Characteristics TA = 25°C unless otherwise noted

Symbol	Characteristic	Max		Units
		2N5484-5486	*MMBF5484-5486	
P _D	Total Device Dissipation	350	225	mW
	Derate above 25°C	2.8	1.8	mW/°C
R _e JC	Thermal Resistance, Junction to Case	125		°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	357	556	°C/W

^{*}Device mounted on FR-4 PCB 1.6" X 1.6" X 0.06."

²⁾ These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.

N-Channel RF Amplifier (continued)

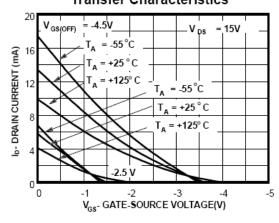
Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
OFF CHAF	RACTERISTICS					
V _{(BR)GSS}	Gate-Source Breakdown Voltage	I _G = - 1.0 μA, V _{DS} = 0	- 25			V
I _{GSS}	Gate Reverse Current	V _{GS} = - 20 V, V _{DS} = 0 V _{GS} = - 20 V, V _{DS} = 0, T _A = 100°C			- 1.0 - 0.2	nA μA
V _{GS(off)}	Gate-Source Cutoff Voltage	V _{DS} = 15 V, I _D = 10 nA 5484 5485 5486	- 0.5		- 3.0 - 4.0 - 6.0	V V
ON CHAR	ACTERISTICS					
I _{DSS}	Zero-Gate Voltage Drain Current*	V _{DS} = 15 V, V _{GS} = 0 5484 5485 5486	4.0		5.0 10 20	mA mA mA
SMALL SIG	GNAL CHARACTERISTICS Forward Transfer Conductance	V _{DS} = 15 V, V _{GS} = 0, f = 1.0 kHz		<u> </u>		<u> </u>
913		5484 5485 5486	3500 4000		6000 7000 8000	μmhos μmhos μmhos
Re(yis)	Input Conductance	V _{DS} = 15 V, V _{GS} = 0, f = 100 MHz 5484 V _{DS} = 15 V, V _{GS} = 0, f = 400 MHz			100	μmhos
		5485 / 5486			1000	μmhos
gos	Output Conductance	V _{DS} = 15 V, V _{GS} = 0, f = 1.0 kHz 5484 5485 5486			50 60 75	μmhos μmhos μmhos
Re ₍ y _{os)}	Output Conductance	V _{DS} = 15 V, V _{GS} = 0, f = 100 MHz 5484 V _{DS} = 15 V, V _{GS} = 0, f = 400 MHz			75	μmhos
		5485 / 5486	3		100	μmhos
Re(yfs)	Forward Transconductance	V _{DS} = 15 V, V _{GS} = 0, f = 100 MHz 5484 V _{DS} = 15 V, V _{GS} = 0, f = 400 MHz	2500			μmhos
		5485 5486	3000			μmhos μmhos
Ciss	Input Capacitance	$V_{DS} = 15 \text{ V}, V_{GS} = 0, f = 1.0 \text{ MHz}$			5.0	pF
CISS	Reverse Transfer Capacitance	$V_{DS} = 15 \text{ V}, V_{GS} = 0, f = 1.0 \text{ MHz}$			1.0	pF
Crss	·					
C _{rss}	Output Capacitance	$V_{DS} = 15 \text{ V}, V_{GS} = 0, f = 1.0 \text{ MHz}$			2.0	pF
Crss	·	V_{DS} = 15 V, R_G = 1.0 k Ω , f = 100 MHz 5484			3.0	dB
C _{rss}	Output Capacitance	V_{DS} = 15 V, R_{G} = 1.0 k Ω ,		4.0		

N-Channel RF Amplifier

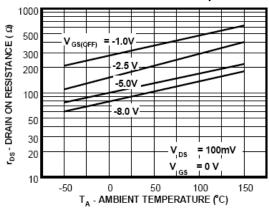
(continued)

Typical Characteristics

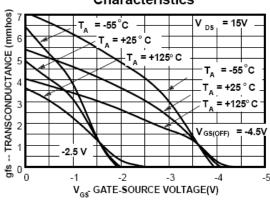
Transfer Characteristics



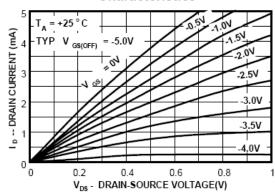
Channel Resistance vs Temperature



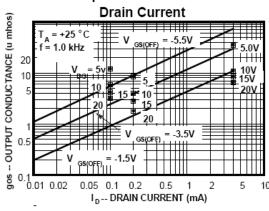
Transconductance Characteristics



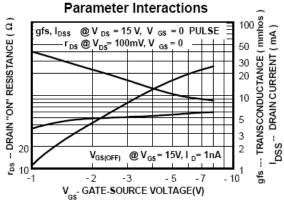
Common Drain-Source Characteristics



Output Conductance vs

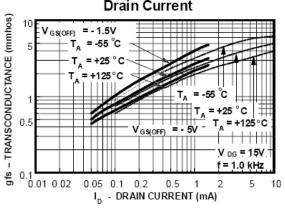


Transconductance

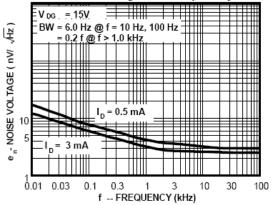


Typical Characteristics (continued)

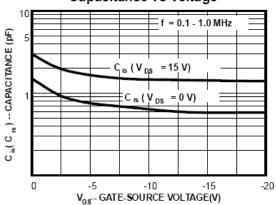
Transconductance vs Drain Current



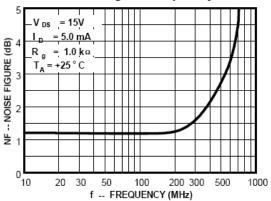
Noise Voltage vs Frequency



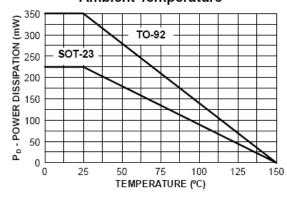
Capacitance vs Voltage



Noise Figure Frequency



Power Dissipation vs. Ambient Temperature

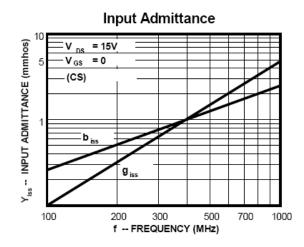


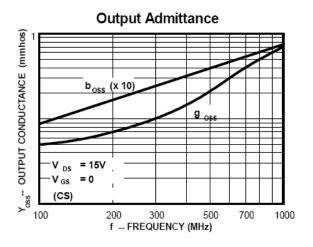
Rev. 1.0.0

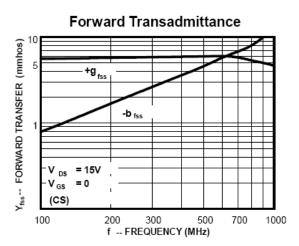
N-Channel RF Amplifier

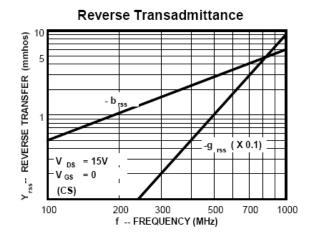
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Common Source Characteristics







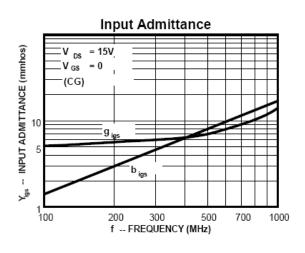


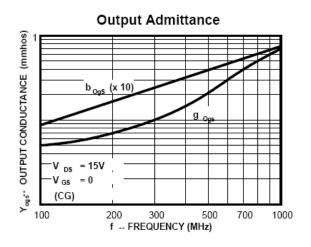
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N-Channel RF Amplifier

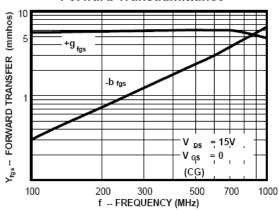
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Common Gate Characteristics

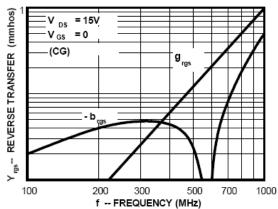




Forward Transadmittance



Reverse Transadmittance







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